

SN75ALS172A QUADRUPLE DIFFERENTIAL LINE DRIVER

SLLS121D – AUGUST 1990 – REVISED APRIL 1998

查询"SN75ALS172A"供应商

- Meets or Exceeds ANSI Standards EIA/TIA-422-B and RS-485 and ITU Recommendation V.11
- High-Speed Advanced Low-Power Schottky Circuitry
- Designed for 20-MBaud Operation in Both Serial and Parallel Applications
- Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments
- Low Supply-Current Requirements: 55 mA Max
- Wide Positive and Negative Input/Output Bus-Voltage Ranges
- Driver Output Capacity . . . ± 60 mA
- Thermal Shutdown Protection
- Driver Positive and Negative Current Limiting
- Logically Interchangeable With SN75172

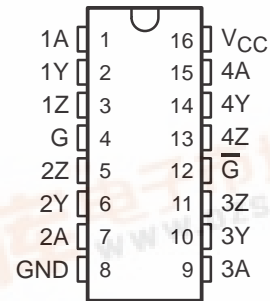
description

The SN75ALS172A comprises four line drivers with 3-state differential outputs. They are designed to meet the requirements of ANSI Standards EIA/TIA-422-B and RS-485 and ITU Recommendation V.11. This device is optimized for balanced multipoint bus transmission at rates of up to 20 Mbaud. Each driver features wide positive and negative common-mode output voltage ranges, making it suitable for party-line applications in noisy environments.

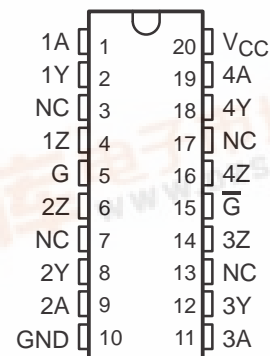
The SN75ALS172A provides positive- and negative-current limiting and thermal shutdown for protection from line-fault conditions on the transmission bus line. Shutdown occurs at a junction temperature of approximately 150°C.

The SN75ALS172A is characterized for operation from 0°C to 70°C.

**N PACKAGE
(TOP VIEW)**



**DW PACKAGE
(TOP VIEW)**



NC – No internal connection



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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SN75ALS172A QUADRUPLE DIFFERENTIAL LINE DRIVER

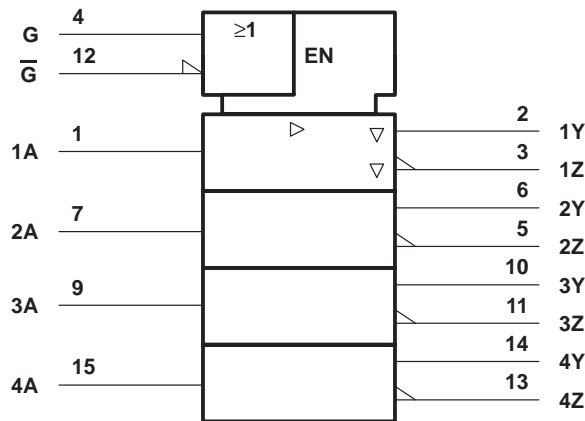
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FUNCTION TABLE
(each driver)

| INPUT A | ENABLES | | OUTPUTS | |
|------------|---------|-----------|---------|---|
| | G | \bar{G} | Y | Z |
| H | H | X | H | L |
| L | H | X | L | H |
| H | X | L | H | L |
| L | X | L | L | H |
| X | L | H | Z | Z |

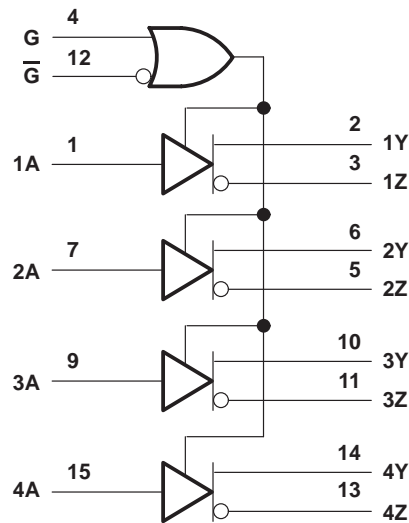
H = high level, L = low level, X = irrelevant,
Z = high impedance (off)

logic symbol†



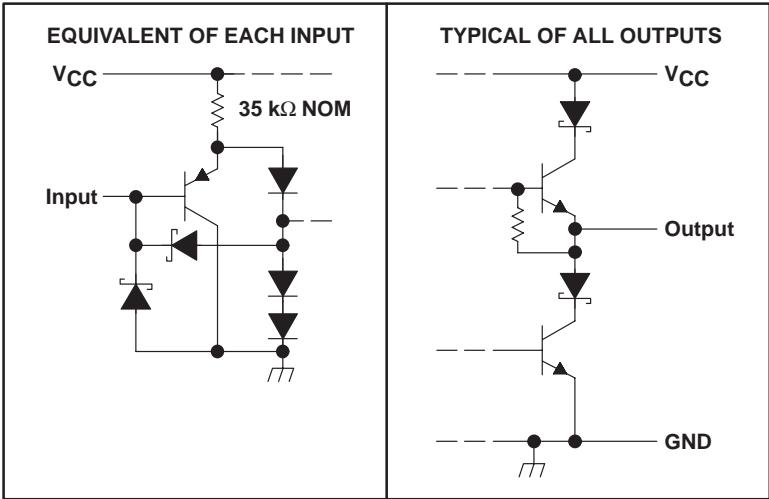
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the N package.

logic diagram (positive logic)



Pin numbers shown are for the N package.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|--|------------------------------|
| Supply voltage, V_{CC} (see Note 1) | 7 V |
| Input voltage, V_I | 7 V |
| Output voltage range, V_O | -9 V to 14 V |
| Continuous total dissipation | See Dissipation Rating Table |
| Storage temperature range, T_{stg} | -65°C to 150°C |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE

| PACKAGE | $T_A \leq 25^\circ\text{C}$ POWER RATING | DERATING FACTOR | $T_A = 70^\circ\text{C}$ POWER RATING | $T_A = 85^\circ\text{C}$ POWER RATING |
|---------|---|--------------------|--|--|
| DW | 1125 mW | 9 mW/°C | 720 mW | 585 mW |
| N | 1150 mW | 9.2 mW/°C | 736 mW | 598 mW |

recommended operating conditions

| | MIN | NOM | MAX | UNIT |
|---------------------------------------|------|-----|----------|------|
| Supply voltage, V_{CC} | 4.75 | 5 | 5.25 | V |
| High-level input voltage, V_{IH} | 2 | | | V |
| Low-level input voltage, V_{IL} | | | 0.8 | V |
| Common-mode output voltage, V_{OC} | | | 12 -7 | V |
| High-level output current, I_{OH} | | | -60 | mA |
| Low-level output current, I_{OL} | | | 60 | mA |
| Operating free-air temperature, T_A | 0 | | 70 | °C |

SN75ALS172A

QUADRUPLE DIFFERENTIAL LINE DRIVER

SLLS499B "A" ICs 1990 75ALS172A 998

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP† | MAX | UNIT | |
|--|--|-------------------------------|------|---------------------------------------|---------------|----|
| V_{IK} Input clamp voltage | $I_I = -18 \text{ mA}$ | | | -1.5 | V | |
| V_O Output voltage | $I_O = 0$ | 0 | | 6 | V | |
| $ V_{OD1} $ Differential output voltage | $I_O = 0$ | 1.5 | | 6 | V | |
| $ V_{OD2} $ Differential output voltage | $V_{CC} = 5 \text{ V}, R_L = 100 \Omega,$ See Figure 1 | $1/2 V_{OD1}$ or 2^\ddagger | | | V | |
| | $R_L = 54 \Omega,$ See Figure 1 | 1.5 | 2.5 | 5 | | |
| $ V_{OD3} $ Differential output voltage | See Note 2 | 1.5 | | 5 | V | |
| $\Delta V_{OD} $ Change in magnitude of differential output voltage§ | $R_L = 54 \Omega$ or $100 \Omega,$ See Figure 1 | | | ± 0.2 | V | |
| V_{OC} Common-mode output voltage¶ | $R_L = 54 \Omega$ or $100 \Omega,$ See Figure 1 | | | $\begin{matrix} 3 \\ -1 \end{matrix}$ | V | |
| $\Delta V_{OC} $ Change in magnitude of common-mode output voltage§ | $R_L = 54 \Omega$ or $100 \Omega,$ See Figure 1 | | | ± 0.2 | V | |
| I_O Output current with power off | $V_{CC} = 0,$ $V_O = -7 \text{ V}$ to 12 V | | | ± 100 | μA | |
| I_{OZ} High-impedance-state output current | $V_O = -7 \text{ V}$ to 12 V | | | ± 100 | μA | |
| I_{IH} High-level input current | $V_I = 2.7 \text{ V}$ | | | 20 | μA | |
| I_{IL} Low-level input current | $V_I = 0.4 \text{ V}$ | | | -100 | μA | |
| I_{OS} Short-circuit output current | $V_O = -7 \text{ V}$ to 12 V | | | ± 250 | mA | |
| I_{CC} Supply current (all drivers) | No load | Outputs enabled | | 36 | 55 | mA |
| | | Outputs disabled | | 15 | 30 | |

† All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^\circ\text{C}$.

‡ The minimum V_{OD2} with a $100\text{-}\Omega$ load is either $1/2 V_{OD1}$ or 2 V , whichever is greater.

§ $\Delta|V_{OD}|$ and $\Delta|V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input is changed from a high level to a low level.

¶ In ANSI Standard EIA/TIA-422-B, V_{OC} , which is the average of the two output voltages with respect to ground, is called output offset voltage, V_{OS} .

NOTE 2: See EIA Standard RS-485, Figure 3-5, Test Termination Measurement 2.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$

| PARAMETER | TEST CONDITIONS | MIN | TYP† | MAX | UNIT |
|---|----------------------------------|-----|------|-----|------|
| $t_d(\text{OD})$ Differential-output delay time | $R_L = 54 \Omega,$ See Figure 2 | 9 | 15 | 22 | ns |
| t_{PZH} Output enable time to high level | $R_L = 110 \Omega,$ See Figure 3 | 30 | 45 | 70 | ns |
| t_{PZL} Output enable time to low level | $R_L = 110 \Omega,$ See Figure 4 | 25 | 40 | 65 | ns |
| t_{PHZ} Output disable time from high level | $R_L = 110 \Omega,$ See Figure 3 | 10 | 20 | 35 | ns |
| t_{PLZ} Output disable time from low level | $R_L = 110 \Omega,$ See Figure 4 | 10 | 30 | 45 | ns |

† All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^\circ\text{C}$.



PARAMETER MEASUREMENT INFORMATION

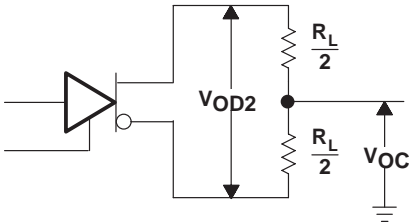
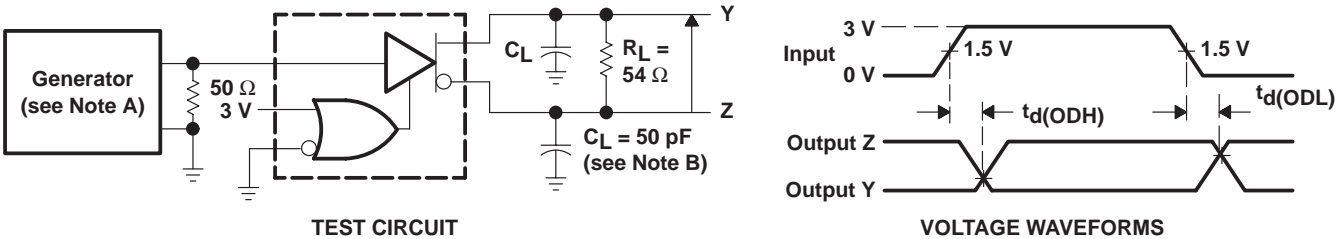
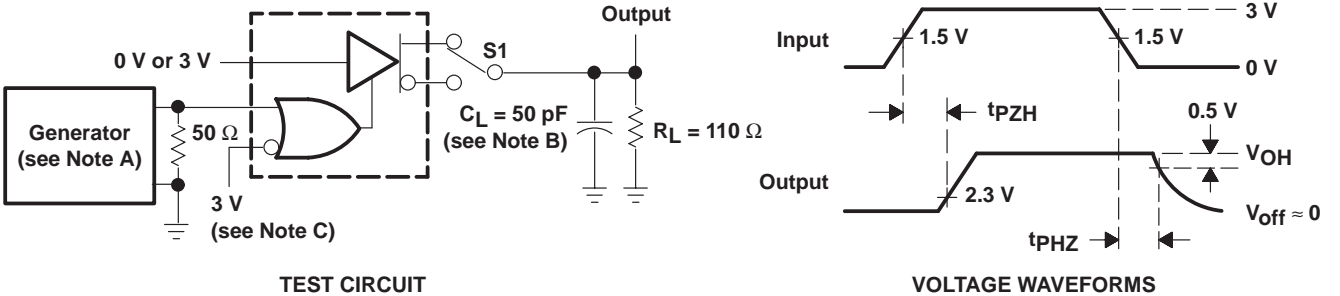


Figure 1. Differential and Common-Mode Output Voltages



NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, $Z_0 = 50 \Omega$, duty cycle = 50%, $t_f \leq 5$ ns, $t_r \leq 5$ ns.
 B. C_L includes probe and stray capacitance.

Figure 2. Differential Output Test Circuit and Voltage Waveforms



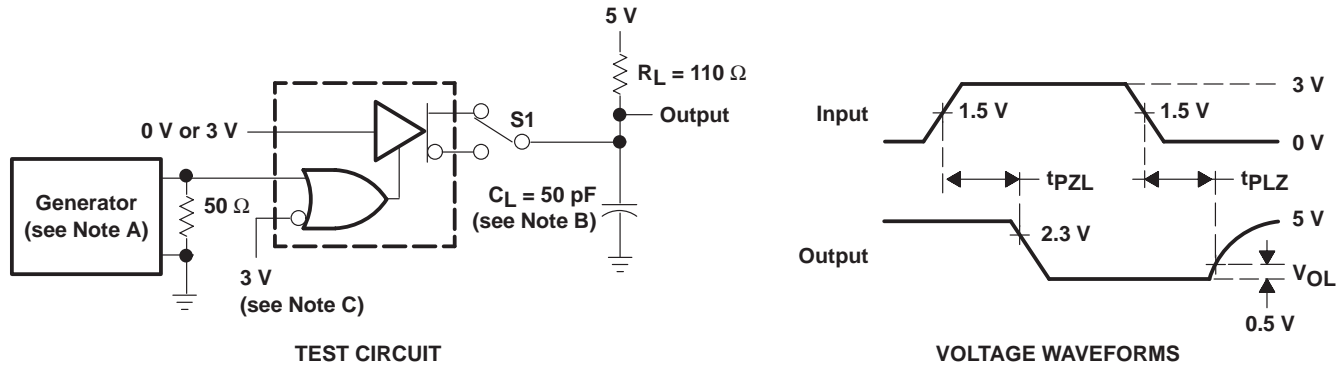
NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, $Z_0 = 50 \Omega$, duty cycle = 50%, $t_f \leq 5$ ns, $t_r \leq 5$ ns.
 B. C_L includes probe and stray capacitance.
 C. To test the active-low enable \bar{G} , ground G and apply an inverted input waveform to \bar{G} .

Figure 3. Test Circuit and Voltage Waveforms, t_{pZH} and t_{pHZ}

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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, $Z_O = 50 \Omega$, duty cycle = 50%, $t_f \leq 5 \text{ ns}$, $t_r \leq 5 \text{ ns}$.
- B. C_L includes probe and stray capacitance.
- C. To test the active-low enable \overline{G} , ground G and apply an inverted input waveform to \overline{G} .

Figure 4. Test Circuit and Voltage Waveforms, t_{PZL} and t_{PLZ}

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN75ALS172ADW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN75ALS172ADWE4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN75ALS172ADWG4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN75ALS172ADWR | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN75ALS172ADWRE4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN75ALS172ADWRG4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN75ALS172AN | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPD | N / A for Pkg Type |
| SN75ALS172ANE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPD | N / A for Pkg Type |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

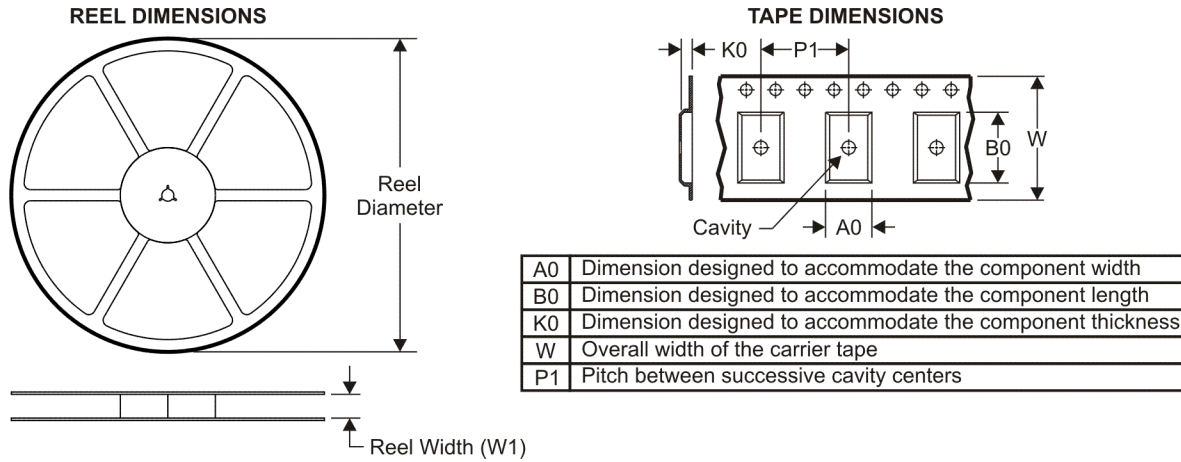
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

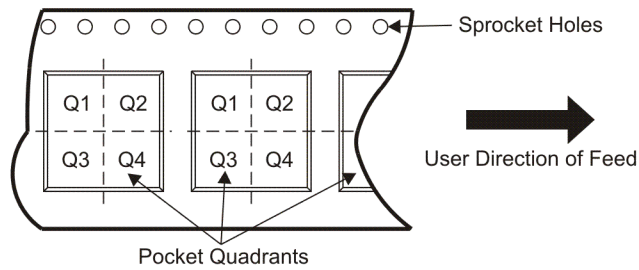
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TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN75ALS172ADWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.1 | 2.65 | 12.0 | 24.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS

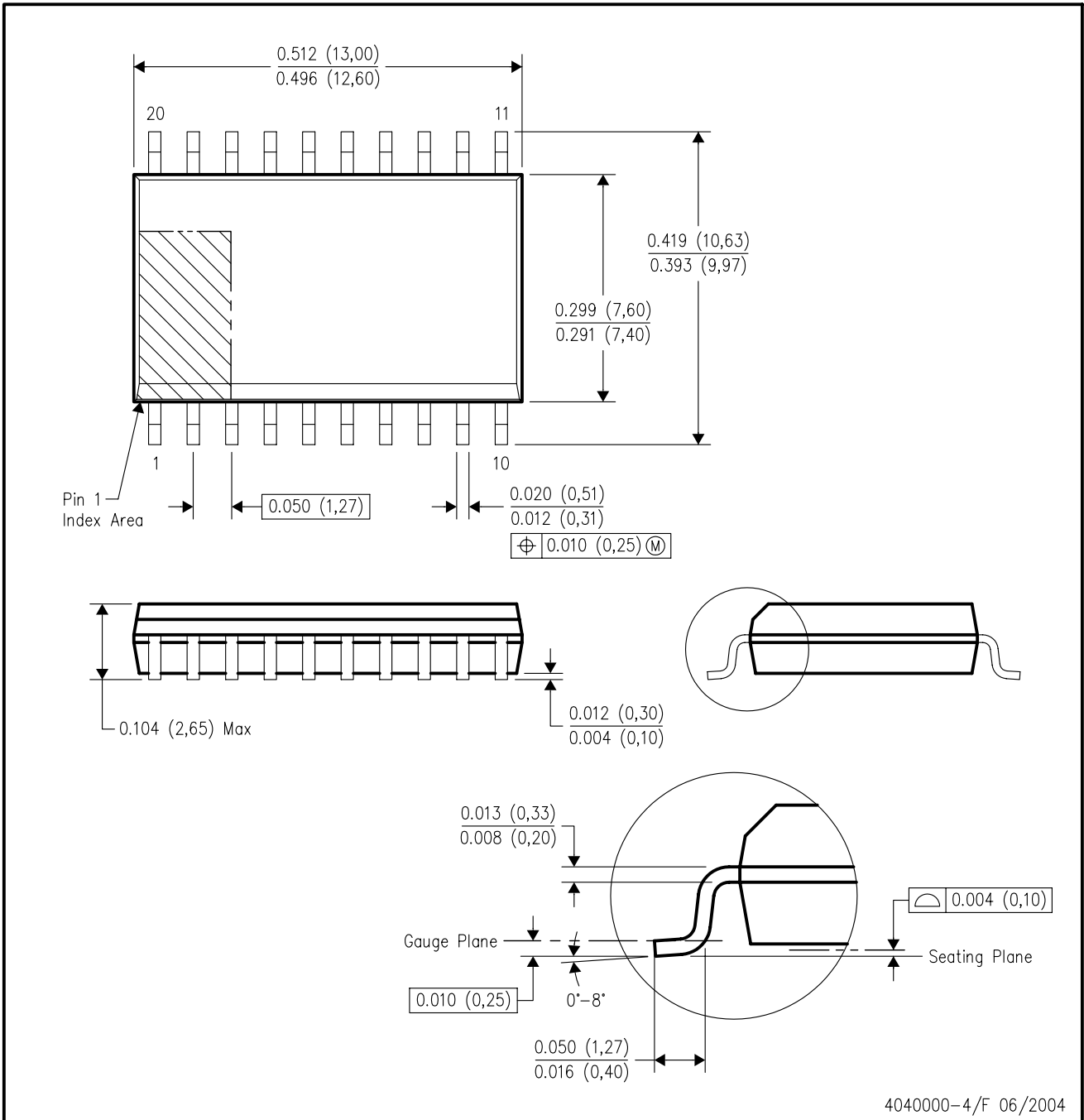


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN75ALS172ADWR | SOIC | DW | 20 | 2000 | 346.0 | 346.0 | 41.0 |

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



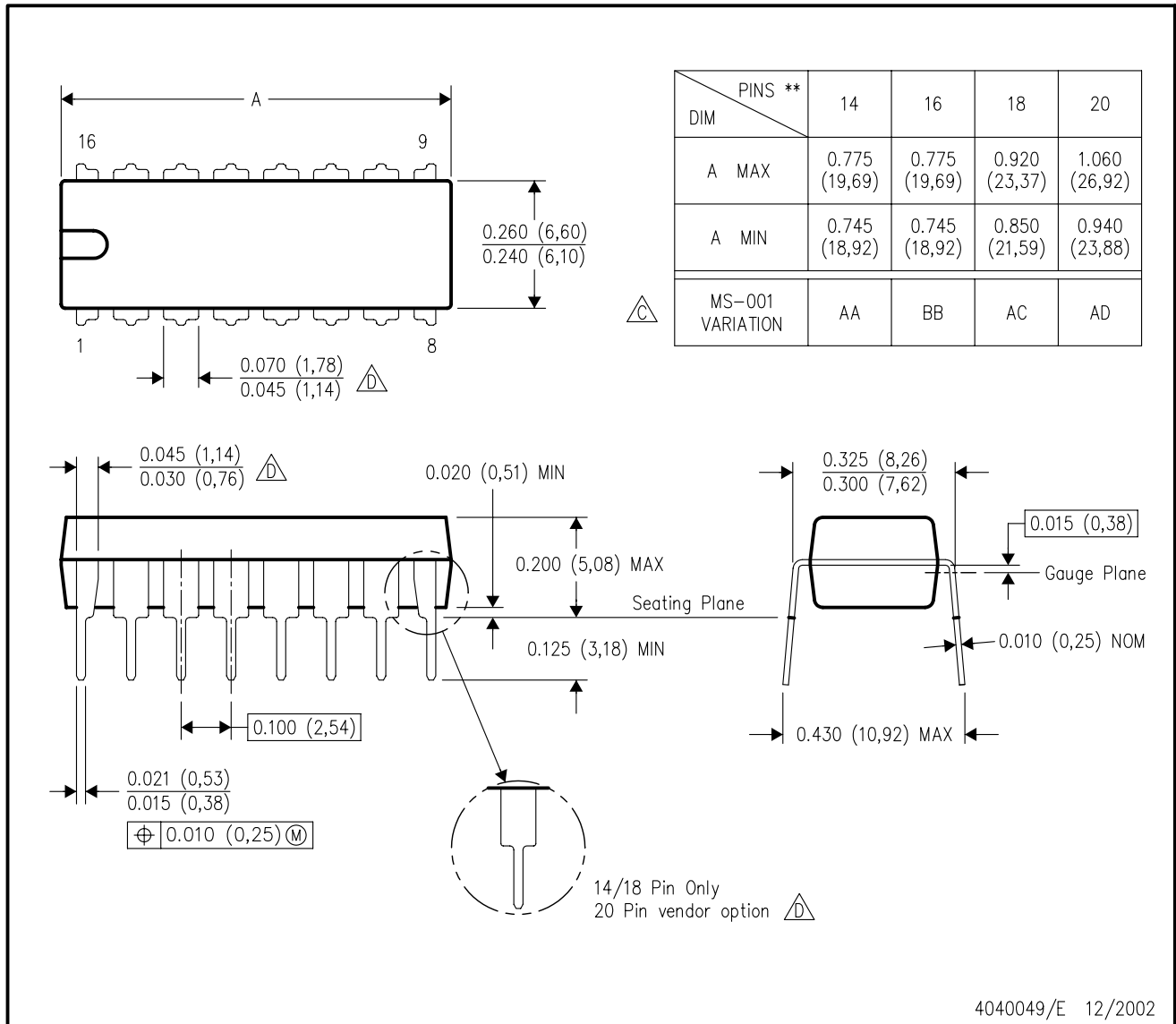
- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-013 variation AC.

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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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